



4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Product Summary

V _{BR (Min)}	I _{PP (Max)}	C _{I/O (Typ)}
5.0V	4.0A	0.28pF

Description

The D3V3XA4B10LP is a high-performance device suitable for protecting four high speed I/Os. These devices are assembled in U-DFN2510-10 package and have high ESD surge capability, low ESD clamping voltage and ultra-low capacitance.

Applications

Typically used at high-speed ports such as USB 3.0, USB 3.1, Serial ATA, Display port.

Features

- Clamping Voltage: 9.4V at 16A TLP
- IEC 61000-4-2 (ESD): Air ±12kV, Contact ±12kV
- IEC 61000-4-5 (Lightning): 4.0A (8/20μs)
- 4 Channels of ESD Protection
- Ultra-Low Channel Input Capacitance of 0.35pF Max
- TLP Dynamic Resistance: 0.39Ω
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

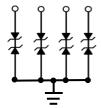
Mechanical Data

- Case: U-DFN2510-10
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead Free Plating).
 Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.038 grams (Approximate)

U-DFN2510-10

in#	Description
2, 4, 5	I/O
', 9, 10	No Connection
3, 8	V_{SS}

Device Schematic



Pin Description (Top View)

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D3V3XA4B10LP-7	Standard	ZS1	7	8	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

U-DFN2510-10

ZS1 YM

ZS1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	2019	2020	2021	2022	2023
Code	F	G	Н		J	K

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	I _{PP}	4.0	Α	I/O to V _{SS} , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P_{PP}	24	W	I/O to V _{SS} , 8/20µs
ESD Protection – Contact Discharge, per IEC 61000-4-2	V _{ESD_CONTACT}	±12	kV	I/O to V _{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	V _{ESD_AIR}	±12	kV	I/O to V _{SS}

Thermal Characteristics

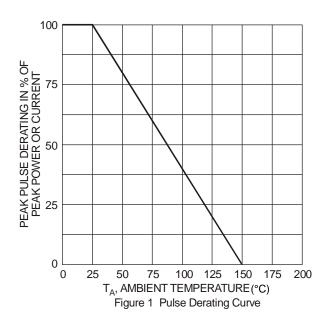
Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P_{D}	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ hetaJA}$	360	°C/W
Operating and Storage Temperature Range	T_{J} , T_{STG}	-55 to +150	°C

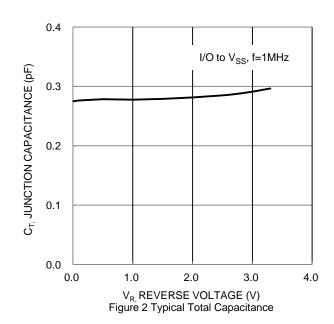
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	3.3	V	<u> </u>
Reverse Current	I _R	_	_	1.0	μΑ	$V_R = 3.3V$, I/O to V_{SS}
Reverse Breakdown Voltage	V_{BR}	5.0	_	9.0	V	$I_R = 1 \text{mA}$, I/O to V_{SS}
Clamping Voltage (Note 6)	Vc	_	9.4	_	V	TLP, 16A, t_P = 100ns, I/O to V_{SS}
Dynamic Reverse Resistance	R _{DIF}	_	0.39	_	Ω	TLP, 10A, t_P = 100ns, I/O to V_{SS}
Channel Input Capacitance	C _{I/O}	_	0.28	0.35	pF	$V_{I/O} = 0V$, $V_{SS} = 0V$, $f = 1MHz$

Notes:

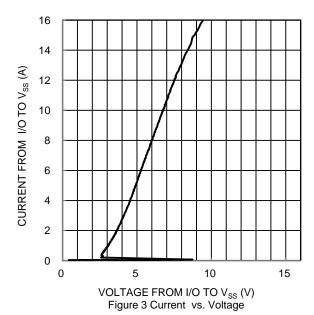
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 6. Clamping voltage value is based on a TLP model. TLP conditions: Z_0 =50 Ω , t_P = 100ns, averaging window; t1=70ns to t2=90ns

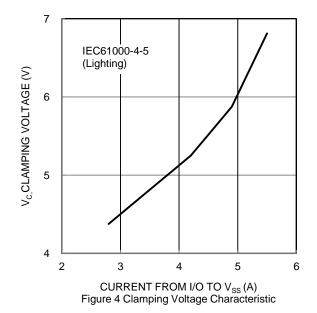










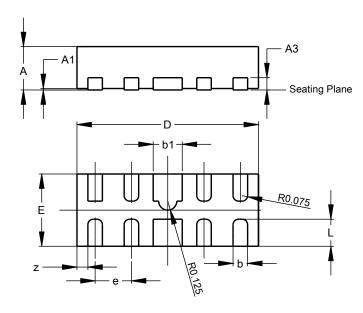




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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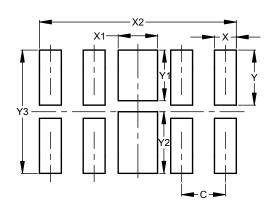


l	U-DFN2510-10						
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
A1	0.00	0.05	0.03				
А3	-	-	0.13				
b	0.15	0.25	0.20				
b1	0.35	0.45	0.40				
D	2.450	2.575	2.500				
е	-	-	0.50				
Е	0.950	1.075	1.000				
L	0.325	0.425	0.375				
Z	-	-	0.150				
All D	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value (in mm)
С	0.500
Х	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1 400



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